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### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	896B (512 x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	36 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 6V
Data Converters	A/D 4x8b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16c710t-04-ss">https://www.e-xfl.com/product-detail/microchip-technology/pic16c710t-04-ss</a>

## 4.0 MEMORY ORGANIZATION

### 4.1 Program Memory Organization

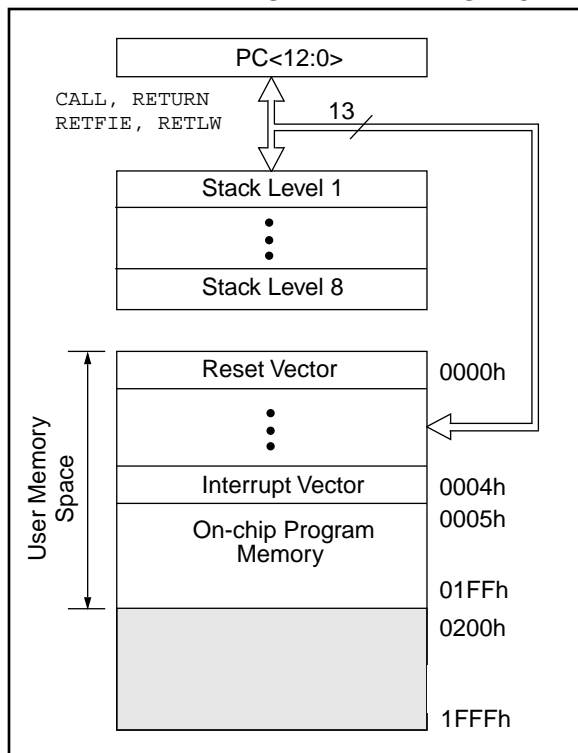
The PIC16C71X family has a 13-bit program counter capable of addressing an 8K x 14 program memory space. The amount of program memory available to each device is listed below:

Device	Program Memory	Address Range
PIC16C710	512 x 14	0000h-01FFh
PIC16C71	1K x 14	0000h-03FFh
PIC16C711	1K x 14	0000h-03FFh
PIC16C715	2K x 14	0000h-07FFh

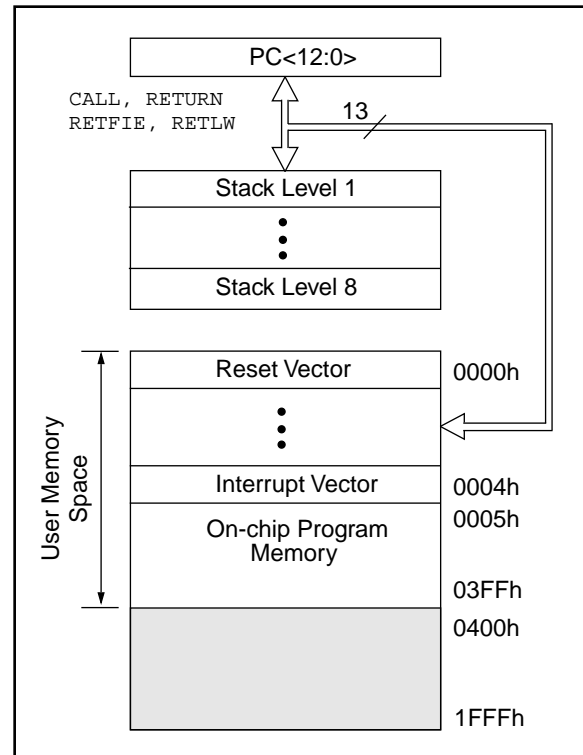
For those devices with less than 8K program memory, accessing a location above the physically implemented address will cause a wraparound.

The reset vector is at 0000h and the interrupt vector is at 0004h.

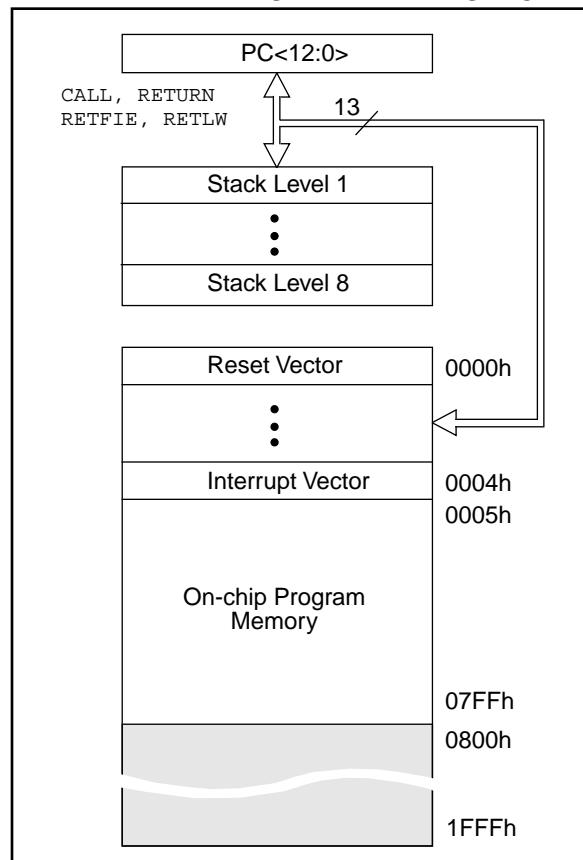
**FIGURE 4-1: PIC16C710 PROGRAM MEMORY MAP AND STACK**



**FIGURE 4-2: PIC16C71/711 PROGRAM MEMORY MAP AND STACK**



**FIGURE 4-3: PIC16C715 PROGRAM MEMORY MAP AND STACK**



## 4.2.2.3 INTCON REGISTER

**Applicable Devices** 710 71 711 715

The INTCON Register is a readable and writable register which contains various enable and flag bits for the TMR0 register overflow, RB Port change and External RB0/INT pin interrupts.

**Note:** Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>).

**FIGURE 4-9: INTCON REGISTER (ADDRESS 0Bh, 8Bh)**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE	ADIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF
bit7							bit0
<p>bit 7: <b>GIE:</b><sup>(1)</sup> Global Interrupt Enable bit  1 = Enables all un-masked interrupts  0 = Disables all interrupts</p> <p>bit 6: <b>ADIE:</b> A/D Converter Interrupt Enable bit  1 = Enables A/D interrupt  0 = Disables A/D interrupt</p> <p>bit 5: <b>T0IE:</b> TMR0 Overflow Interrupt Enable bit  1 = Enables the TMR0 interrupt  0 = Disables the TMR0 interrupt</p> <p>bit 4: <b>INTE:</b> RB0/INT External Interrupt Enable bit  1 = Enables the RB0/INT external interrupt  0 = Disables the RB0/INT external interrupt</p> <p>bit 3: <b>RBIE:</b> RB Port Change Interrupt Enable bit  1 = Enables the RB port change interrupt  0 = Disables the RB port change interrupt</p> <p>bit 2: <b>T0IF:</b> TMR0 Overflow Interrupt Flag bit  1 = TMR0 register has overflowed (must be cleared in software)  0 = TMR0 register did not overflow</p> <p>bit 1: <b>INTF:</b> RB0/INT External Interrupt Flag bit  1 = The RB0/INT external interrupt occurred (must be cleared in software)  0 = The RB0/INT external interrupt did not occur</p> <p>bit 0: <b>RBIF:</b> RB Port Change Interrupt Flag bit  1 = At least one of the RB7:RB4 pins changed state (must be cleared in software)  0 = None of the RB7:RB4 pins have changed state</p> <p>Note 1: For the PIC16C71, if an interrupt occurs while the GIE bit is being cleared, the GIE bit may be unintentionally re-enabled by the RETFIE instruction in the user's Interrupt Service Routine. Refer to Section 8.5 for a detailed description.</p>							
<p>R = Readable bit  W = Writable bit  U = Unimplemented bit, read as '0'  - n = Value at POR reset</p>							
<p>Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON&lt;7&gt;). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.</p>							

## 6.2 Using Timer0 with an External Clock

When an external clock input is used for Timer0, it must meet certain requirements. The requirements ensure the external clock can be synchronized with the internal phase clock (TOSC). Also, there is a delay in the actual incrementing of Timer0 after synchronization.

### 6.2.1 EXTERNAL CLOCK SYNCHRONIZATION

When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 6-5). Therefore, it is necessary for T0CKI to be high for at least 2TOSC (and a small RC delay of 20 ns) and low for at least 2TOSC (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

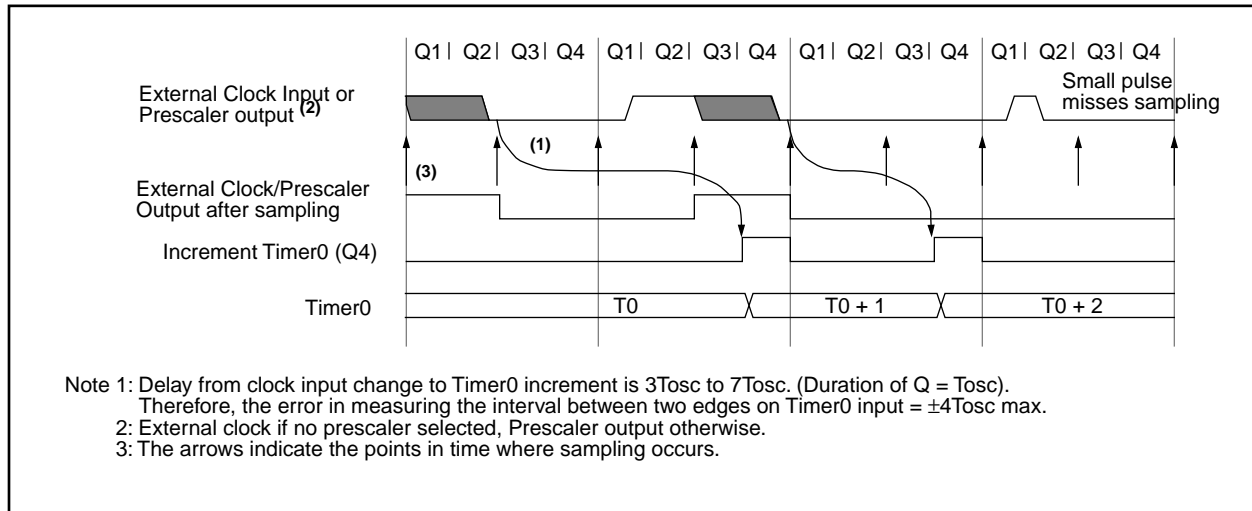
When a prescaler is used, the external clock input is divided by the asynchronous ripple-counter type pres-

caler so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for T0CKI to have a period of at least 4TOSC (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T0CKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

### 6.2.2 TMR0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 6-5 shows the delay from the external clock edge to the timer incrementing.

**FIGURE 6-5: TIMER0 TIMING WITH EXTERNAL CLOCK**



# PIC16C71X

**TABLE 8-3: CERAMIC RESONATORS,  
PIC16C710/711/715**

Ranges Tested:			
Mode	Freq	OSC1	OSC2
XT	455 kHz	68 - 100 pF	68 - 100 pF
	2.0 MHz	15 - 68 pF	15 - 68 pF
	4.0 MHz	15 - 68 pF	15 - 68 pF
HS	8.0 MHz	10 - 68 pF	10 - 68 pF
	16.0 MHz	10 - 22 pF	10 - 22 pF
These values are for design guidance only. See notes at bottom of page.			
Resonators Used:			
455 kHz	Panasonic EFO-A455K04B	± 0.3%	
2.0 MHz	Murata Erie CSA2.00MG	± 0.5%	
4.0 MHz	Murata Erie CSA4.00MG	± 0.5%	
8.0 MHz	Murata Erie CSA8.00MT	± 0.5%	
16.0 MHz	Murata Erie CSA16.00MX	± 0.5%	
All resonators used did not have built-in capacitors.			

**TABLE 8-4: CAPACITOR SELECTION  
FOR CRYSTAL OSCILLATOR,  
PIC16C710/711/715**

Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2
LP	32 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
XT	200 kHz	47-68 pF	47-68 pF
	1 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15-33 pF	15-33 pF
	20 MHz	15-33 pF	15-33 pF
These values are for design guidance only. See notes at bottom of page.			
Crystals Used			
32 kHz	Epson C-001R32.768K-A	± 20 PPM	
200 kHz	STD XTL 200.000KHz	± 20 PPM	
1 MHz	ECS ECS-10-13-1	± 50 PPM	
4 MHz	ECS ECS-40-20-1	± 50 PPM	
8 MHz	EPSON CA-301 8.000M-C	± 30 PPM	
20 MHz	EPSON CA-301 20.000M-C	± 30 PPM	

- Note 1: Recommended values of C1 and C2 are identical to the ranges tested table.
- 2: Higher capacitance increases the stability of oscillator but also increases the start-up time.
- 3: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
- 4: Rs may be required in HS mode as well as XT mode to avoid overdriving crystals with low drive level specification.

## 8.5 Interrupts

<b>Applicable Devices</b>	710	71	711	715
---------------------------	-----	----	-----	-----

The PIC16C71X family has 4 sources of interrupt.

Interrupt Sources
External interrupt RB0/INT
TMR0 overflow interrupt
PORTB change interrupts (pins RB7:RB4)
A/D Interrupt

The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

**Note:** Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

A global interrupt enable bit, GIE (INTCON<7>) enables (if set) all un-masked interrupts or disables (if cleared) all interrupts. When bit GIE is enabled, and an interrupt's flag bit and mask bit are set, the interrupt will vector immediately. Individual interrupts can be disabled through their corresponding enable bits in various registers. Individual interrupt bits are set regardless of the status of the GIE bit. The GIE bit is cleared on reset.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine as well as sets the GIE bit, which re-enables interrupts.

The RB0/INT pin interrupt, the RB port change interrupt and the TMR0 overflow interrupt flags are contained in the INTCON register.

The peripheral interrupt flags are contained in the special function registers PIR1 and PIR2. The corresponding interrupt enable bits are contained in special function registers PIE1 and PIE2, and the peripheral interrupt enable bit is contained in special function register INTCON.

When an interrupt is responded to, the GIE bit is cleared to disable any further interrupt, the return address is pushed onto the stack and the PC is loaded with 0004h. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

For external interrupt events, such as the INT pin or PORTB change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends when the interrupt event occurs (Figure 8-19). The latency is the same for one or two cycle instructions. Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

**Note:** For the PIC16C71  
If an interrupt occurs while the Global Interrupt Enable (GIE) bit is being cleared, the GIE bit may unintentionally be re-enabled by the user's Interrupt Service Routine (the RETFIE instruction). The events that would cause this to occur are:

1. An instruction clears the GIE bit while an interrupt is acknowledged.
2. The program branches to the Interrupt vector and executes the Interrupt Service Routine.
3. The Interrupt Service Routine completes with the execution of the RETFIE instruction. This causes the GIE bit to be set (enables interrupts), and the program returns to the instruction after the one which was meant to disable interrupts.

Perform the following to ensure that interrupts are globally disabled:

```

LOOP BCF    INTCON, GIE    ; Disable global
                             ; interrupt bit
      BTFSC INTCON, GIE    ; Global interrupt
                             ; disabled?
      GOTO  LOOP           ; NO, try again
      :                   ; Yes, continue
                             ; with program
                             ; flow

```

COMF		Complement f						
Syntax:	[ <i>label</i> ] COMF f,d							
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$							
Operation:	$(\bar{f}) \rightarrow (\text{dest})$							
Status Affected:	Z							
Encoding:	<table><tr><td>00</td><td>1001</td><td>dfff</td><td>ffff</td></tr></table>				00	1001	dfff	ffff
00	1001	dfff	ffff					
Description:	The contents of register 'f' are complemented. If 'd' is 0 the result is stored in W. If 'd' is 1 the result is stored back in register 'f'.							
Words:	1							
Cycles:	1							
Q Cycle Activity:	Q1	Q2	Q3	Q4				
	Decode	Read register 'f'	Process data	Write to dest				

**Example**

```
COMF    REG1, 0

Before Instruction
    REG1 = 0x13
After Instruction
    REG1 = 0x13
    W    = 0xEC
```

DECf		Decrement f						
Syntax:	[label] DECf f,d							
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$							
Operation:	$(f) - 1 \rightarrow (\text{dest})$							
Status Affected:	Z							
Encoding:	<table><tr><td>00</td><td>0011</td><td>dfff</td><td>ffff</td></tr></table>				00	0011	dfff	ffff
00	0011	dfff	ffff					
Description:	Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.							
Words:	1							
Cycles:	1							
Q Cycle Activity:	Q1	Q2	Q3	Q4				
	Decode	Read register 'f'	Process data	Write to dest				

**Example**

```
DECf    CNT, 1

Before Instruction
    CNT = 0x01
    Z   = 0
After Instruction
    CNT = 0x00
    Z   = 1
```

DECFSZ		Decrement f, Skip if 0			
Syntax:	[ <i>label</i> ] DECFSZ f,d				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	$(f) - 1 \rightarrow (\text{dest}); \quad \text{skip if result} = 0$				
Status Affected:	None				
Encoding:	00	1011	dfff	ffff	
Description:	The contents of register 'f' are decremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 1, the next instruction, is executed. If the result is 0, then a NOP is executed instead making it a 2Tcy instruction.				
Words:	1				
Cycles:	1(2)				
Q Cycle Activity:	Q1	Q2	Q3	Q4	
	Decode	Read register 'f'	Process data	Write to dest	
If Skip:	(2nd Cycle)				
	Q1	Q2	Q3	Q4	
	NOP	NOP	NOP	NOP	

**Example**

```
HERE    DECFSZ    CNT, 1
        GOTO      LOOP
CONTINUE •
        •
        •

Before Instruction
    PC = address HERE
After Instruction
    CNT = CNT - 1
    if CNT = 0,
    PC = address CONTINUE
    if CNT ≠ 0,
    PC = address HERE+1
```

# PIC16C71X

## SLEEP

Syntax: [ *label* ] SLEEP

Operands: None

Operation: 00h → WDT,  
0 → WDT prescaler,  
1 →  $\overline{TO}$ ,  
0 →  $\overline{PD}$

Status Affected:  $\overline{TO}$ ,  $\overline{PD}$

Encoding: 

00	0000	0110	0011
----	------	------	------

Description: The power-down status bit,  $\overline{PD}$  is cleared. Time-out status bit,  $\overline{TO}$  is set. Watchdog Timer and its prescaler are cleared. The processor is put into SLEEP mode with the oscillator stopped. See Section 8.8 for more details.

Words: 1

Cycles: 1

Q Cycle Activity: 

Q1	Q2	Q3	Q4
Decode	NOP	NOP	Go to Sleep

Example: SLEEP

## SUBLW

### Subtract W from Literal

Syntax: [ *label* ] SUBLW k

Operands:  $0 \leq k \leq 255$

Operation:  $k - (W) \rightarrow (W)$

Status Affected: C, DC, Z

Encoding: 

11	110x	kkkk	kkkk
----	------	------	------

Description: The W register is subtracted (2's complement method) from the eight bit literal 'k'. The result is placed in the W register.

Words: 1

Cycles: 1

Q Cycle Activity: 

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process data	Write to W

Example 1: SUBLW 0x02

Before Instruction

W = 1  
C = ?  
Z = ?

After Instruction

W = 1  
C = 1; result is positive  
Z = 0

Example 2: Before Instruction

W = 2  
C = ?  
Z = ?

After Instruction

W = 0  
C = 1; result is zero  
Z = 1

Example 3: Before Instruction

W = 3  
C = ?  
Z = ?

After Instruction

W = 0xFF  
C = 0; result is negative  
Z = 0



## SUBWF Subtract W from f

Syntax: [label] SUBWF f,d

Operands:  $0 \leq f \leq 127$   
 $d \in [0,1]$

Operation:  $(f) - (W) \rightarrow (\text{dest})$

Status Affected: C, DC, Z

Encoding:

00	0010	dfff	ffff
----	------	------	------

Description: Subtract (2's complement method) W register from register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process data	Write to dest

Example 1: SUBWF REG1, 1

Before Instruction

```

REG1 = 3
W     = 2
C     = ?
Z     = ?

```

After Instruction

```

REG1 = 1
W     = 2
C     = 1; result is positive
Z     = 0

```

Example 2: Before Instruction

```

REG1 = 2
W     = 2
C     = ?
Z     = ?

```

After Instruction

```

REG1 = 0
W     = 2
C     = 1; result is zero
Z     = 1

```

Example 3: Before Instruction

```

REG1 = 1
W     = 2
C     = ?
Z     = ?

```

After Instruction

```

REG1 = 0xFF
W     = 2
C     = 0; result is negative
Z     = 0

```

## SWAPF Swap Nibbles in f

Syntax: [label] SWAPF f,d

Operands:  $0 \leq f \leq 127$   
 $d \in [0,1]$

Operation:  $(f<3:0>) \rightarrow (\text{dest}<7:4>),$   
 $(f<7:4>) \rightarrow (\text{dest}<3:0>)$

Status Affected: None

Encoding:

00	1110	dfff	ffff
----	------	------	------

Description: The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0 the result is placed in W register. If 'd' is 1 the result is placed in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process data	Write to dest

Example SWAPF REG, 0

Before Instruction

```
REG1 = 0xA5
```

After Instruction

```

REG1 = 0xA5
W     = 0x5A

```

## TRIS Load TRIS Register

Syntax: [label] TRIS f

Operands:  $5 \leq f \leq 7$

Operation:  $(W) \rightarrow \text{TRIS register } f;$

Status Affected: None

Encoding:

00	0000	0110	0fff
----	------	------	------

Description: The instruction is supported for code compatibility with the PIC16C5X products. Since TRIS registers are readable and writable, the user can directly address them.

Words: 1

Cycles: 1

Example

**To maintain upward compatibility with future PIC16CXX products, do not use this instruction.**

# PIC16C71X

## XORLW Exclusive OR Literal with W

Syntax: `[label] XORLW k`

Operands:  $0 \leq k \leq 255$

Operation:  $(W) .XOR. k \rightarrow (W)$

Status Affected: Z

Encoding: 

11	1010	kkkk	kkkk
----	------	------	------

Description: The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W register.

Words: 1

Cycles: 1

Q Cycle Activity: 

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process data	Write to W

Example: `XORLW 0xAF`  
Before Instruction  
W = 0xB5  
After Instruction  
W = 0x1A

## XORWF Exclusive OR W with f

Syntax: `[label] XORWF f,d`

Operands:  $0 \leq f \leq 127$   
 $d \in [0,1]$

Operation:  $(W) .XOR. (f) \rightarrow (dest)$

Status Affected: Z

Encoding: 

00	0110	dfff	ffff
----	------	------	------

Description: Exclusive OR the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity: 

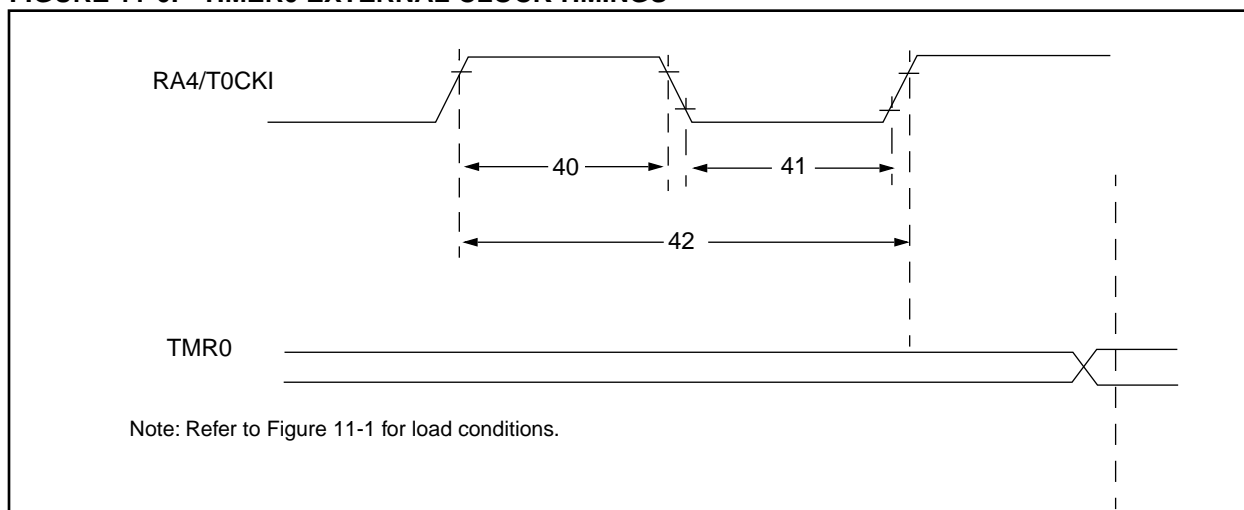
Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process data	Write to dest

Example `XORWF REG 1`  
Before Instruction  
REG = 0xAF  
W = 0xB5  
After Instruction  
REG = 0x1A  
W = 0xB5

# PIC16C71X

Applicable Devices 710 71 711 715

**FIGURE 11-6: TIMER0 EXTERNAL CLOCK TIMINGS**



**TABLE 11-5: TIMER0 EXTERNAL CLOCK REQUIREMENTS**

Param No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width	No Prescaler	$0.5T_{CY} + 20^*$	—	—	ns	Must also meet parameter 42
			With Prescaler	$10^*$	—	—	ns	
41	Tt0L	T0CKI Low Pulse Width	No Prescaler	$0.5T_{CY} + 20^*$	—	—	ns	Must also meet parameter 42
			With Prescaler	$10^*$	—	—	ns	
42	Tt0P	T0CKI Period		Greater of: $20 \text{ ns or } \frac{T_{CY} + 40^*}{N}$		—	ns	N = prescale value (2, 4,..., 256)
48	Tcke2tmr1	Delay from external clock edge to timer increment		$2T_{osc}$	—	$7T_{osc}$	—	

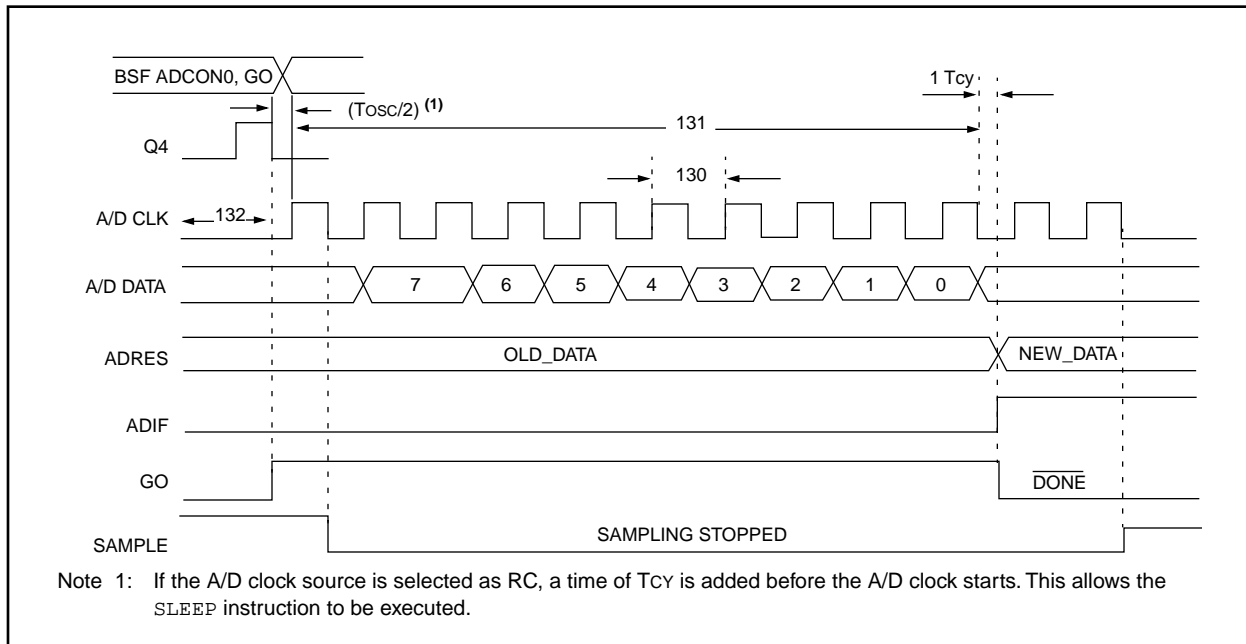
\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

# PIC16C71X

Applicable Devices 710 71 711 715

**FIGURE 11-7: A/D CONVERSION TIMING**



**TABLE 11-7: A/D CONVERSION REQUIREMENTS**

Param No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
130	TAD	A/D clock period	PIC16C710/711	1.6	—	—	μs	TOSC based, VREF ≥ 3.0V
			PIC16LC710/711	2.0	—	—	μs	TOSC based, VREF full range
			PIC16C710/711	2.0*	4.0	6.0	μs	A/D RC mode
			PIC16LC710/711	3.0*	6.0	9.0	μs	A/D RC mode
131	TCNV	Conversion time (not including S/H time). (Note 1)		—	9.5	—	TAD	
132	TACQ	Acquisition time		Note 2	20	—	μs	The minimum time is the amplifier settling time. This may be used if the "new" input voltage has not changed by more than 1 LSb (i.e., 19.5 mV @ 5.12V) from the last sampled voltage (as stated on CHOLD).
				5*	—	—	μs	
134	TGO	Q4 to AD clock start		—	TOSC/2§	—	—	If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to be executed.
135	Tswc	Switching from convert → sample time		1.5§	—	—	TAD	

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

Note 1: ADRES register may be read on the following  $T_{CY}$  cycle.

2: See Section 7.1 for min conditions.

12.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES FOR PIC16C710 AND PIC16C711

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed.

In some graphs or tables the data presented are outside specified operating range (i.e., outside specified VDD range). This is for information only and devices are guaranteed to operate properly only within the specified range.

**Note:** The data presented in this section is a statistical summary of data collected on units from different lots over a period of time and matrix samples. 'Typical' represents the mean of the distribution at, 25°C, while 'max' or 'min' represents (mean +3σ) and (mean -3σ) respectively where σ is standard deviation.

FIGURE 12-1: TYPICAL IPD vs. VDD (WDT DISABLED, RC MODE)

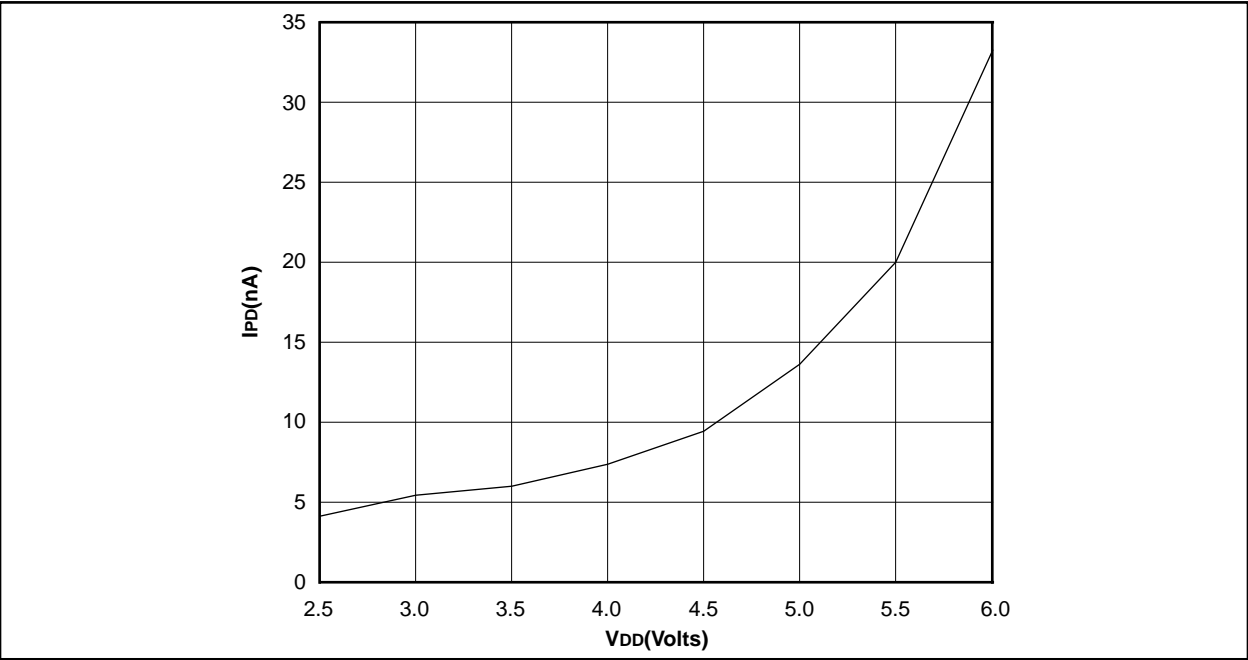
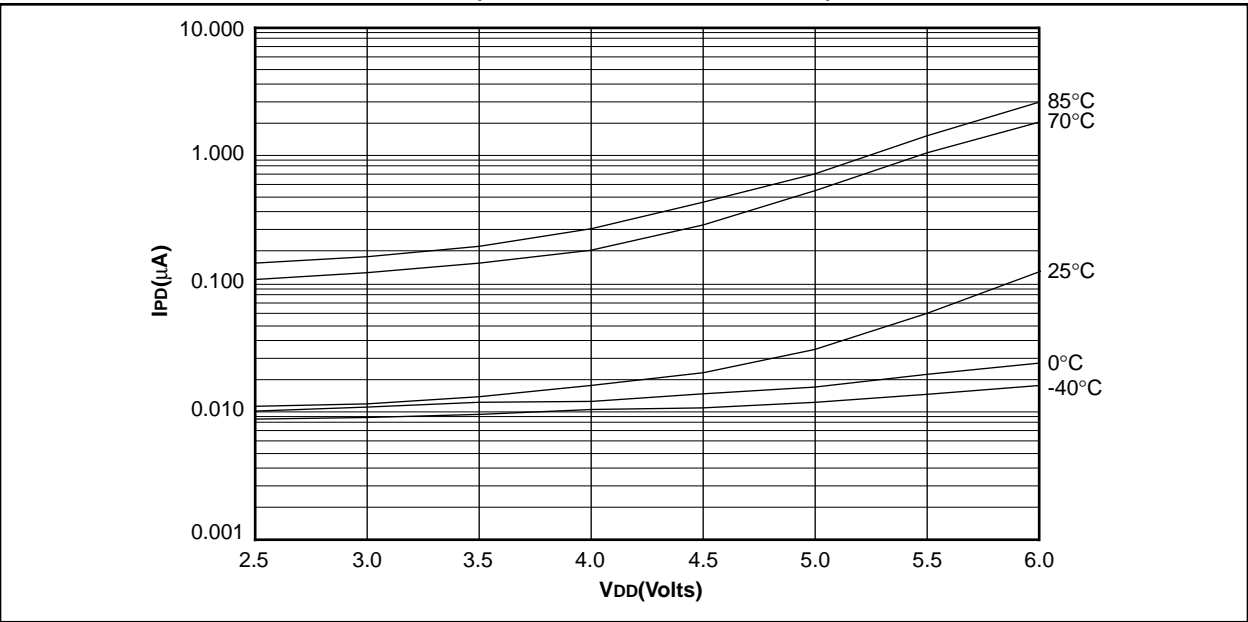


FIGURE 12-2: MAXIMUM IPD vs. VDD (WDT DISABLED, RC MODE)



**13.3 DC Characteristics:** PIC16C715-04 (Commercial, Industrial, Extended)  
PIC16C715-10 (Commercial, Industrial, Extended)  
PIC16C715-20 (Commercial, Industrial, Extended)  
PIC16LC715-04 (Commercial, Industrial))

<b>Standard Operating Conditions (unless otherwise stated)</b> Operating temperature 0°C ≤ TA ≤ +70°C (commercial) -40°C ≤ TA ≤ +85°C (industrial) -40°C ≤ TA ≤ +125°C (extended) Operating voltage VDD range as described in DC spec Section 13.1 and Section 13.2.							
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
D030 D031 D032 D033	<b>Input Low Voltage</b> I/O ports	VIL					
	with TTL buffer		VSS	-	0.5V	V	
	with Schmitt Trigger buffer		VSS	-	0.2VDD	V	
	MCLR, RA4/T0CKI, OSC1 (in RC mode)		VSS	-	0.2VDD	V	
D033	OSC1 (in XT, HS and LP)		VSS	-	0.3VDD	V	Note1
D040 D040A D041 D042 D042A D043	<b>Input High Voltage</b> I/O ports	VIH					
	with TTL buffer		2.0	-	VDD	V	4.5 ≤ VDD ≤ 5.5V
			0.8VDD	-	VDD	V	For VDD > 5.5V or VDD < 4.5V
	with Schmitt Trigger buffer		0.8VDD	-	VDD	V	For entire VDD range
	MCLR, RA4/T0CKI RB0/INT		0.8VDD	-	VDD	V	
	OSC1 (XT, HS and LP)		0.7VDD	-	VDD	V	Note1
D043	OSC1 (in RC mode)		0.9VDD	-	VDD	V	
D070	PORTB weak pull-up current	IPURB	50	250	400	µA	VDD = 5V, VPIN = VSS
D060 D061 D063	<b>Input Leakage Current</b> (Notes 2, 3) I/O ports	IIL	-	-	±1	µA	VSS ≤ VPIN ≤ VDD, Pin at hi-impedance
	MCLR, RA4/T0CKI		-	-	±5	µA	VSS ≤ VPIN ≤ VDD
	OSC1		-	-	±5	µA	VSS ≤ VPIN ≤ VDD, XT, HS and LP osc configuration
D080 D080A D083 D083A	<b>Output Low Voltage</b> I/O ports	VOL	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C
			-	-	0.6	V	IOL = 7.0 mA, VDD = 4.5V, -40°C to +125°C
	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C
			-	-	0.6	V	IOL = 1.2 mA, VDD = 4.5V, -40°C to +125°C

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C7X be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as coming out of the pin.

13.4 Timing Parameter Symbolology

The timing parameter symbols have been created following one of the following formats:

- 1. TppS2ppS
- 2. TppS

T		T	
F	Frequency	T	Time

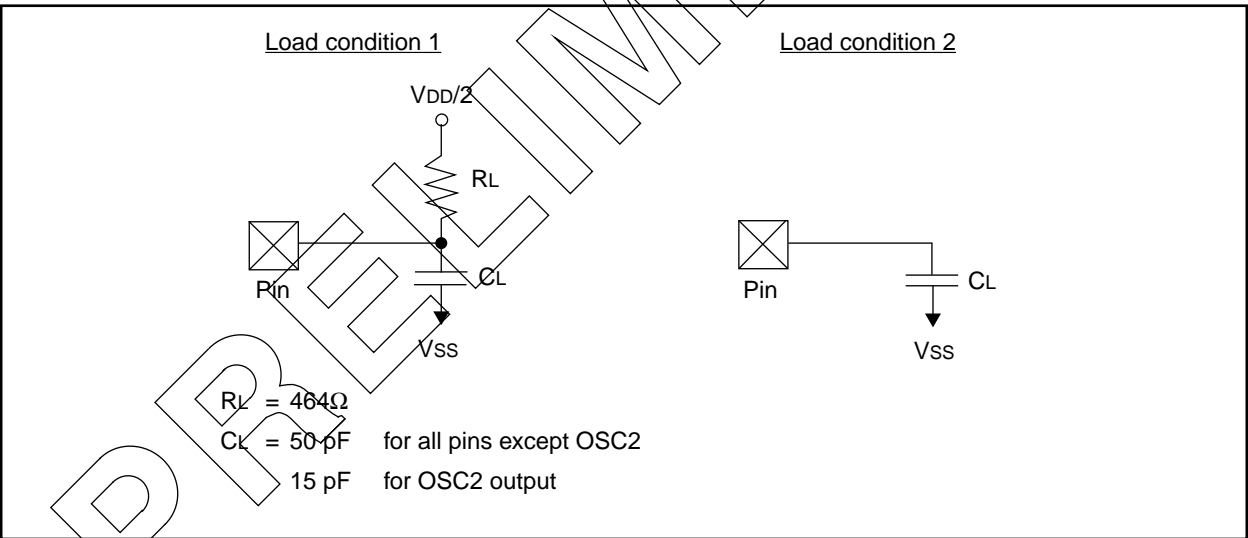
Lowercase letters (pp) and their meanings:

pp			
cc	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	ss	SS
dt	Data in	t0	T0CKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR

Uppercase letters and their meanings:

S			
F	Fall	P	Period
H	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance

FIGURE 13-1: LOAD CONDITIONS



# PIC16C71X

Applicable Devices 710 71 711 715

## 13.5 Timing Diagrams and Specifications

FIGURE 13-2: EXTERNAL CLOCK TIMING

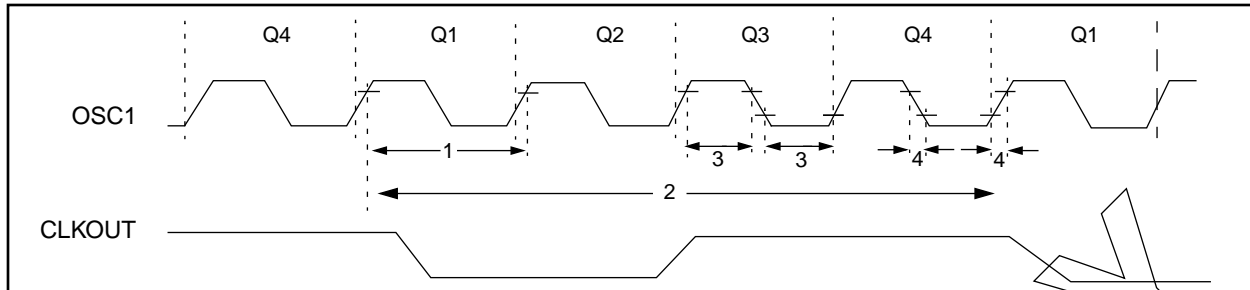


TABLE 13-2: CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	Fos	<b>External CLKIN Frequency (Note 1)</b>	DC	—	4	MHz	XT osc mode
			DC	—	4	MHz	HS osc mode (PIC16C715-04)
			DC	—	20	MHz	HS osc mode (PIC16C715-20)
			DC	—	200	kHz	LP osc mode
		<b>Oscillator Frequency (Note 1)</b>	DC	—	4	MHz	RC osc mode
			0.1	—	4	MHz	XT osc mode
			4	—	4	MHz	HS osc mode (PIC16C715-04)
			4	—	10	MHz	HS osc mode (PIC16C715-10)
			4	—	20	MHz	HS osc mode (PIC16C715-20)
			5	—	200	kHz	LP osc mode
1	Tosc	<b>External CLKIN Period (Note 1)</b>	250	—	—	ns	XT osc mode
			250	—	—	ns	HS osc mode (PIC16C715-04)
			100	—	—	ns	HS osc mode (PIC16C715-10)
			50	—	—	ns	HS osc mode (PIC16C715-20)
			5	—	—	μs	LP osc mode
			—	—	—	—	—
		<b>Oscillator Period (Note 1)</b>	250	—	—	ns	RC osc mode
			250	—	10,000	ns	XT osc mode
			250	—	250	ns	HS osc mode (PIC16C715-04)
			100	—	250	ns	HS osc mode (PIC16C715-10)
2	Tcy	<b>Instruction Cycle Time (Note 1)</b>	200	—	DC	ns	Tcy = 4/Fosc
			—	—	—	—	—
3	TosL, TosH	<b>External Clock in (OSC1) High or Low Time</b>	50	—	—	ns	XT oscillator
			2.5	—	—	μs	LP oscillator
			10	—	—	ns	HS oscillator
4	TosR, TosF	<b>External Clock in (OSC1) Rise or Fall Time</b>	—	—	25	ns	XT oscillator
			—	—	50	ns	LP oscillator
			—	—	15	ns	HS oscillator

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (Tcy) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices. OSC2 is disconnected (has no loading) for the PIC16C715.



FIGURE 14-8: TYPICAL  $I_{PD}$  vs.  $V_{DD}$  BROWN-OUT DETECT ENABLED (RC MODE)

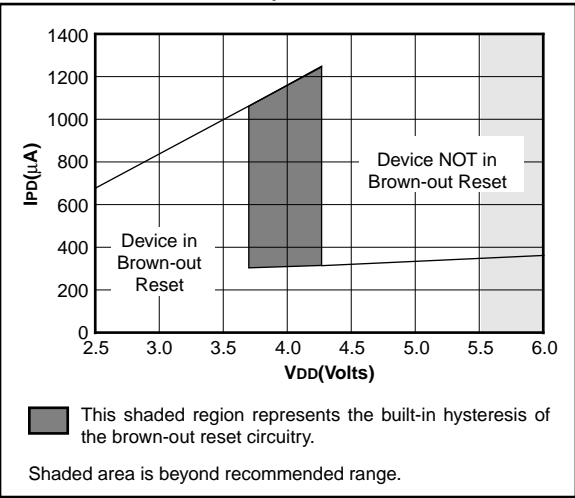


FIGURE 14-9: MAXIMUM  $I_{PD}$  vs.  $V_{DD}$  BROWN-OUT DETECT ENABLED (85°C TO -40°C, RC MODE)

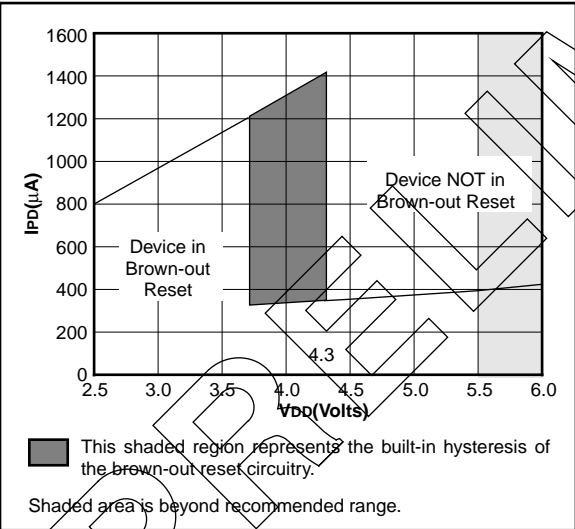


FIGURE 14-10: TYPICAL  $I_{PD}$  vs. TIMER1 ENABLED (32 kHz, RC0/RC1 = 33 pF/33 pF, RC MODE)

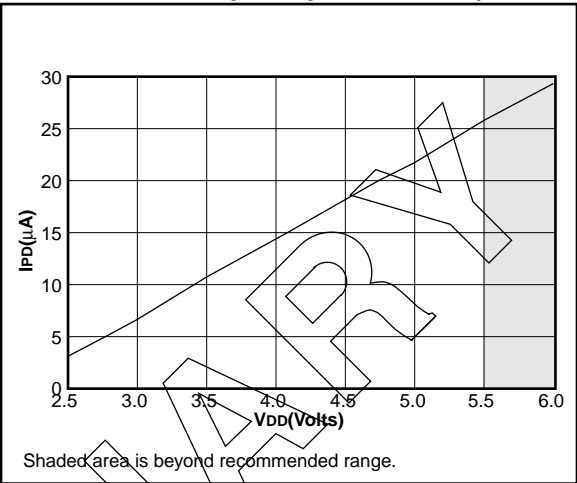
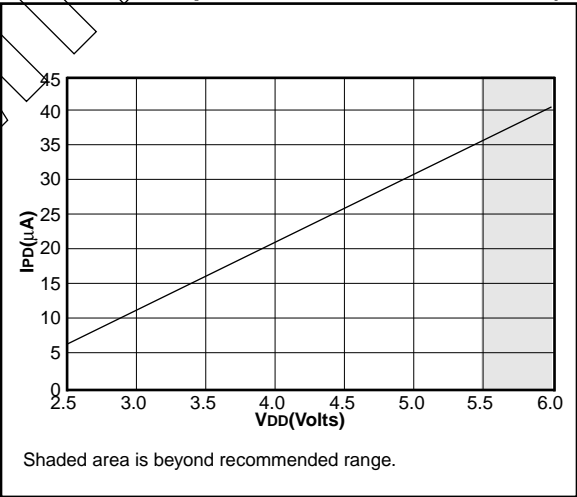
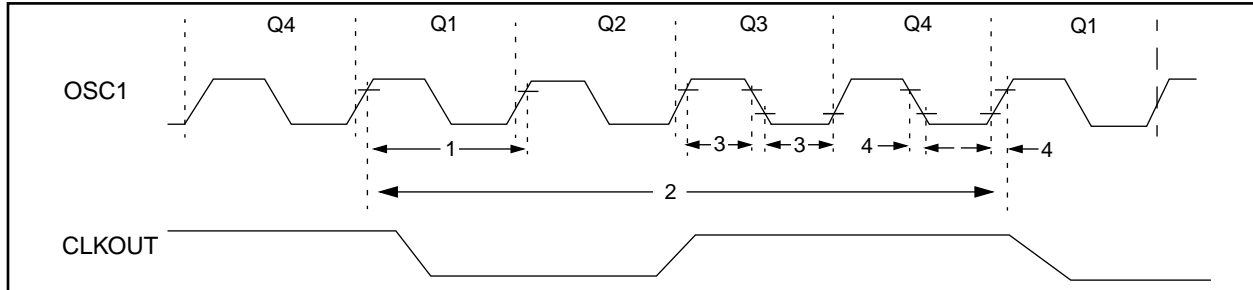


FIGURE 14-11: MAXIMUM  $I_{PD}$  vs. TIMER1 ENABLED (32 kHz, RC0/RC1 = 33 pF/33 pF, 85°C TO -40°C, RC MODE)



## 15.5 Timing Diagrams and Specifications

**FIGURE 15-2: EXTERNAL CLOCK TIMING**



**TABLE 15-2: EXTERNAL CLOCK TIMING REQUIREMENTS**

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	Fosc	<b>External CLKIN Frequency (Note 1)</b>	DC	—	4	MHz	XT osc mode
			DC	—	4	MHz	HS osc mode (-04)
			DC	—	20	MHz	HS osc mode (-20)
			DC	—	200	kHz	LP osc mode
		<b>Oscillator Frequency (Note 1)</b>	DC	—	4	MHz	RC osc mode
			0.1	—	4	MHz	XT osc mode
			1	—	4	MHz	HS osc mode
			1	—	20	MHz	HS osc mode
1	Tosc	<b>External CLKIN Period (Note 1)</b>	250	—	—	ns	XT osc mode
			250	—	—	ns	HS osc mode (-04)
			50	—	—	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
		<b>Oscillator Period (Note 1)</b>	250	—	—	ns	RC osc mode
			250	—	10,000	ns	XT osc mode
			250	—	1,000	ns	HS osc mode (-04)
			50	—	1,000	ns	HS osc mode (-20)
2	TCY	<b>Instruction Cycle Time (Note 1)</b>	1.0	TCY	DC	μs	TCY = 4/Fosc
			15	—	—	ns	HS oscillator
3	TosL, TosH	<b>External Clock in (OSC1) High or Low Time</b>	50	—	—	ns	XT oscillator
			2.5	—	—	μs	LP oscillator
			10	—	—	ns	HS oscillator
4	TosR, TosF	<b>External Clock in (OSC1) Rise or Fall Time</b>	25	—	—	ns	XT oscillator
			50	—	—	ns	LP oscillator
			15	—	—	ns	HS oscillator

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices. OSC2 is disconnected (has no loading) for the PIC16C71.

# PIC16C71X

Applicable Devices 710 71 711 715

FIGURE 16-14: MAXIMUM I<sub>DD</sub> vs. FREQ WITH A/D OFF (EXT CLOCK, -55° TO +125°C)

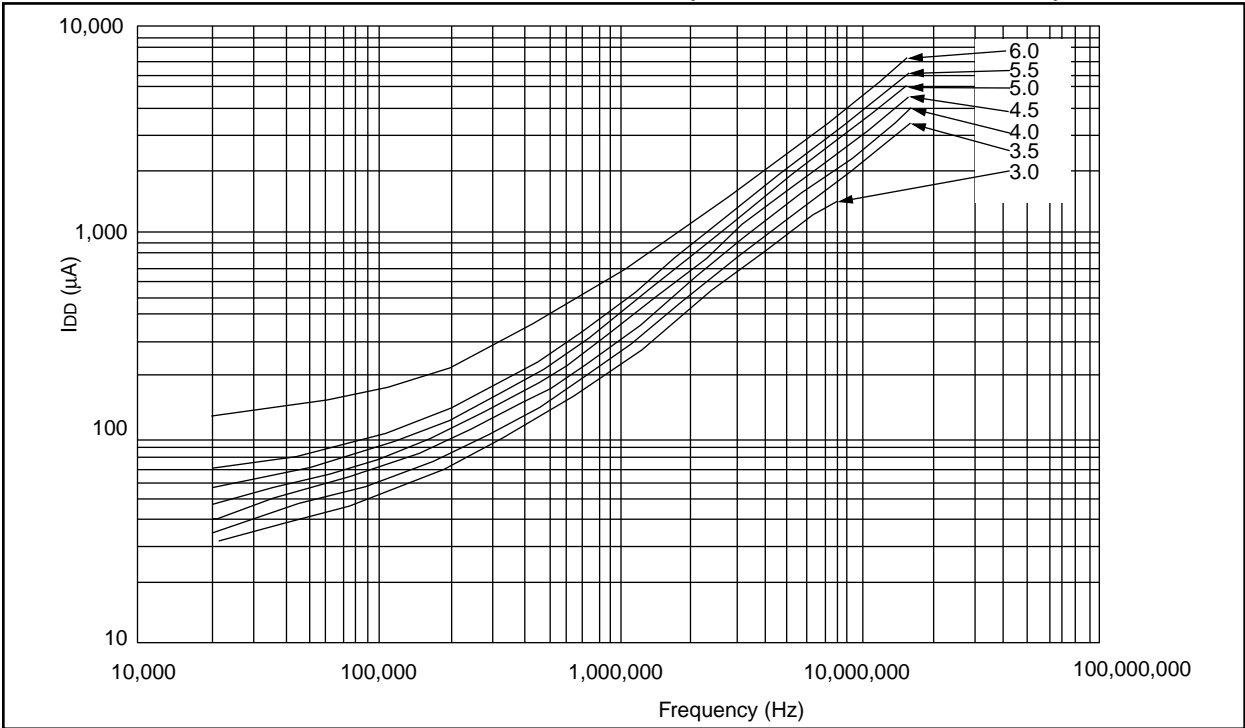


FIGURE 16-15: WDT TIMER TIME-OUT PERIOD vs. V<sub>DD</sub>

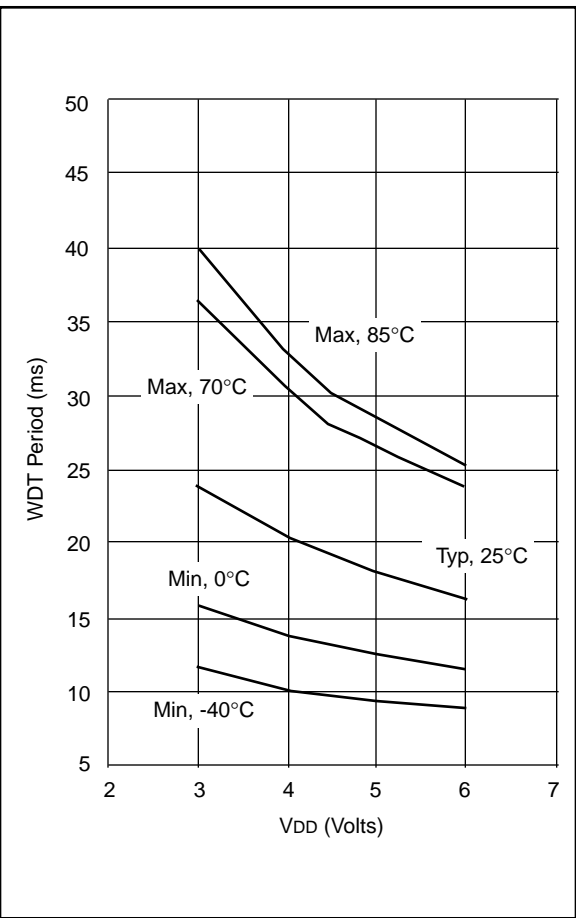
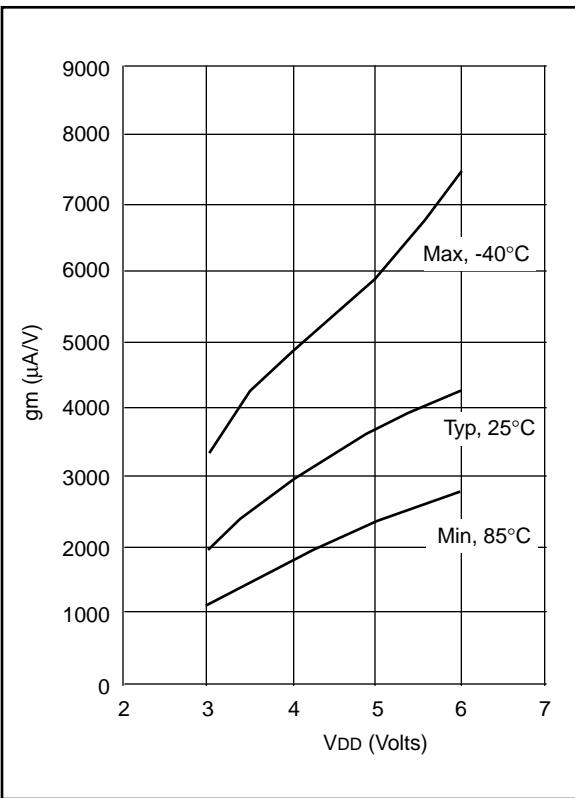


FIGURE 16-16: TRANSCONDUCTANCE (gm) OF HS OSCILLATOR vs. V<sub>DD</sub>



Data based on matrix samples. See first page of this section for details.

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